

# Global Molded Interconnect Device (MID) Supply, Demand and Key Producers, 2023-2029

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## Abstracts

The global Molded Interconnect Device (MID) market size is expected to reach \$ 40800 million by 2029, rising at a market growth of 2.4% CAGR during the forecast period (2023-2029).

Molded interconnect device refers to three-dimensional electromechanical components that combine the finest of mechanical and electrical engineering. These are used to describe the method of producing selectively plated plastic pieces.

This report studies the global Molded Interconnect Device (MID) production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Molded Interconnect Device (MID), and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2022 as the base year. This report explores demand trends and competition, as well as details the characteristics of Molded Interconnect Device (MID) that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global Molded Interconnect Device (MID) total production and demand, 2018-2029, (K Units)

Global Molded Interconnect Device (MID) total production value, 2018-2029, (USD Million)

Global Molded Interconnect Device (MID) production by region & country, production,

value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Molded Interconnect Device (MID) consumption by region & country, CAGR, 2018-2029 & (K Units)

U.S. VS China: Molded Interconnect Device (MID) domestic production, consumption, key domestic manufacturers and share

Global Molded Interconnect Device (MID) production by manufacturer, production, price, value and market share 2018-2023, (USD Million) & (K Units)

Global Molded Interconnect Device (MID) production by Type, production, value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Molded Interconnect Device (MID) production by Application production, value, CAGR, 2018-2029, (USD Million) & (K Units)

This reports profiles key players in the global Molded Interconnect Device (MID) market based on the following parameters – company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Molex LLC, TE Connectivity, Amphenol Corporation, LPKF Laser & Electronics AG, 2E mechatronic GmbH & Co. KG, Harting Technologiegruppe, Arlington Plating Company, MID Solutions and MacDermid Inc., etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals, COVID-19 and Russia-Ukraine War Influence.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Molded Interconnect Device (MID) market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (K Units) and average price (US\$/Unit) by manufacturer, by Type, and by Application. Data is given for the years 2018-2029 by year with 2022 as the base year, 2023 as the estimate year, and 2024-2029 as the forecast year.

## Global Molded Interconnect Device (MID) Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

## Global Molded Interconnect Device (MID) Market, Segmentation by Type

Antenna and Connectivity Modules

Connectors and Switches

Sensors

Lighting

## Global Molded Interconnect Device (MID) Market, Segmentation by Application

Automotive

Healthcare

Industrial

Military

Aerospace

Companies Profiled:

Molex LLC

TE Connectivity

Amphenol Corporation

LPKF Laser & Electronics AG

2E mechatronic GmbH & Co. KG

Harting Technologiegruppe

Arlington Plating Company

MID Solutions

MacDermid Inc.

JOHNAN Corporation

TactoTek Oy

Axon' Cable S.A.S

S2P Solutions

Suzhou Cicor Technology Co. Ltd.

Chogori Technology

Key Questions Answered

1. How big is the global Molded Interconnect Device (MID) market?
2. What is the demand of the global Molded Interconnect Device (MID) market?
3. What is the year over year growth of the global Molded Interconnect Device (MID) market?
4. What is the production and production value of the global Molded Interconnect Device (MID) market?
5. Who are the key producers in the global Molded Interconnect Device (MID) market?
6. What are the growth factors driving the market demand?

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